



US00D870709S

(12) **United States Design Patent** (10) **Patent No.:** **US D870,709 S**  
**Meyer** (45) **Date of Patent:** **\*\* Dec. 24, 2019**

(54) **HEADPHONE**

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(\*\*) Term: **15 Years**

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(51) **LOC (12) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/223; D14/205**

(58) **Field of Classification Search**  
USPC .... D14/203.1, 204–206, 208–210, 212–217, D14/219, 221–225, 249, 372, 433, 138 R, D14/182, 188, 191–194, 172, 496; D29/112; D28/41; D2/875; D24/173–175, 106; D3/294, 273; D13/118, 108, 119  
CPC ..... H04R 25/02; H04R 25/00; H04R 1/10; H04R 1/1016; H04R 1/105; H04R 1/1083; H04R 1/02; H04R 1/1041; H04R 1/28; H04R 5/033; H04R 2420/07; H04R 2430/00; H04R 2430/01  
See application file for complete search history.

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(57) **CLAIM**

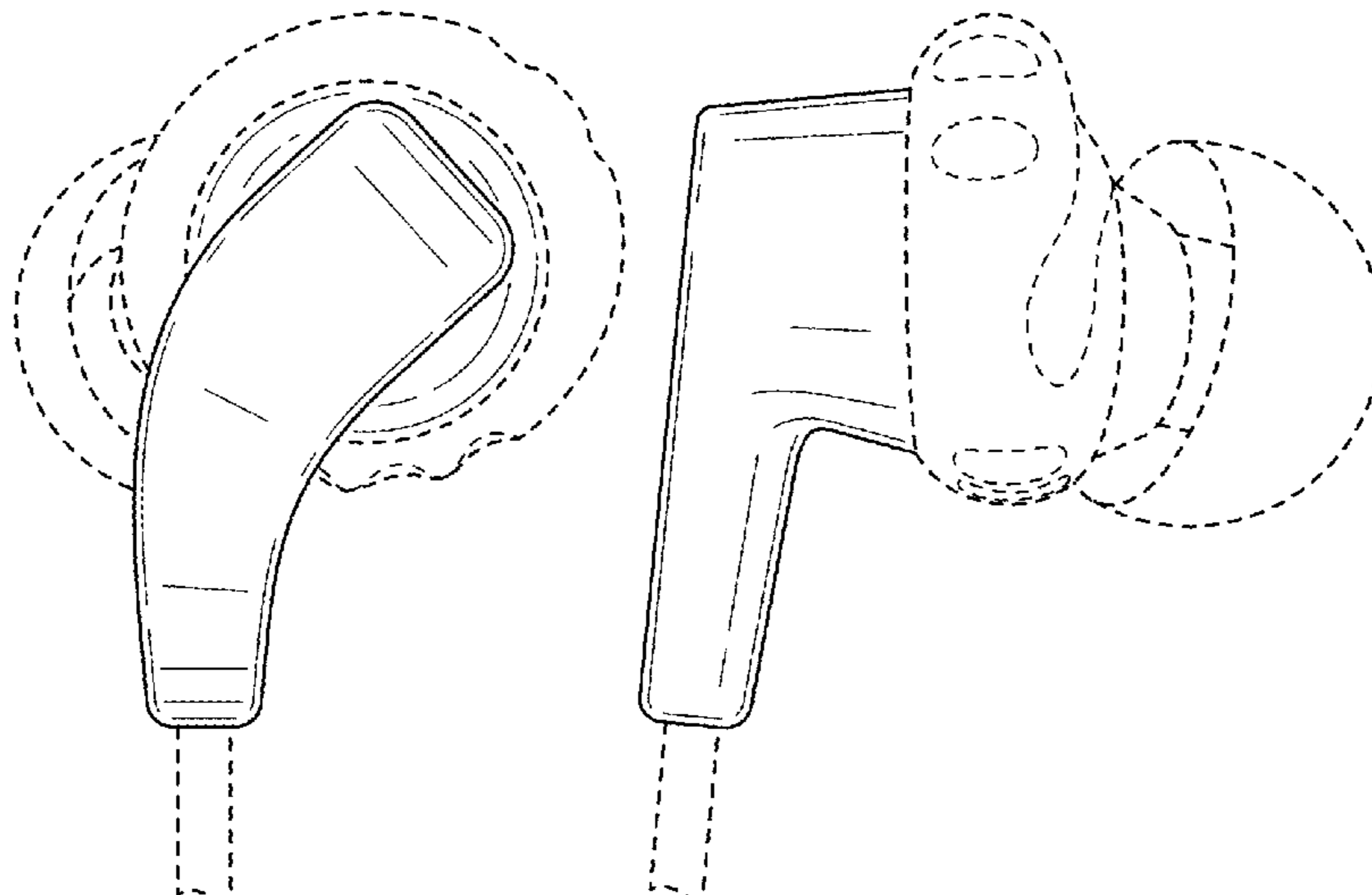
The ornamental design for a headphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a headphone showing the new design in a first embodiment;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a side elevational view thereof;  
FIG. 5 is an opposite side elevational view thereof;  
FIG. 6 is a top view thereof;  
FIG. 7 is a bottom view thereof;  
FIG. 8 is a perspective view of the headphone in a second embodiment, illustrating a mirror image of the headphone of FIGS. 1-7;  
FIG. 9 is a front elevational view thereof;  
FIG. 10 is a rear elevational view thereof;  
FIG. 11 is a side elevational view thereof;  
FIG. 12 is an opposite side elevational view thereof;  
FIG. 13 is a top view thereof; and,  
FIG. 14 is a bottom view thereof.

The broken lines shown in the drawings depict portions of the headphone that form no part of the claimed design.

**1 Claim, 8 Drawing Sheets**



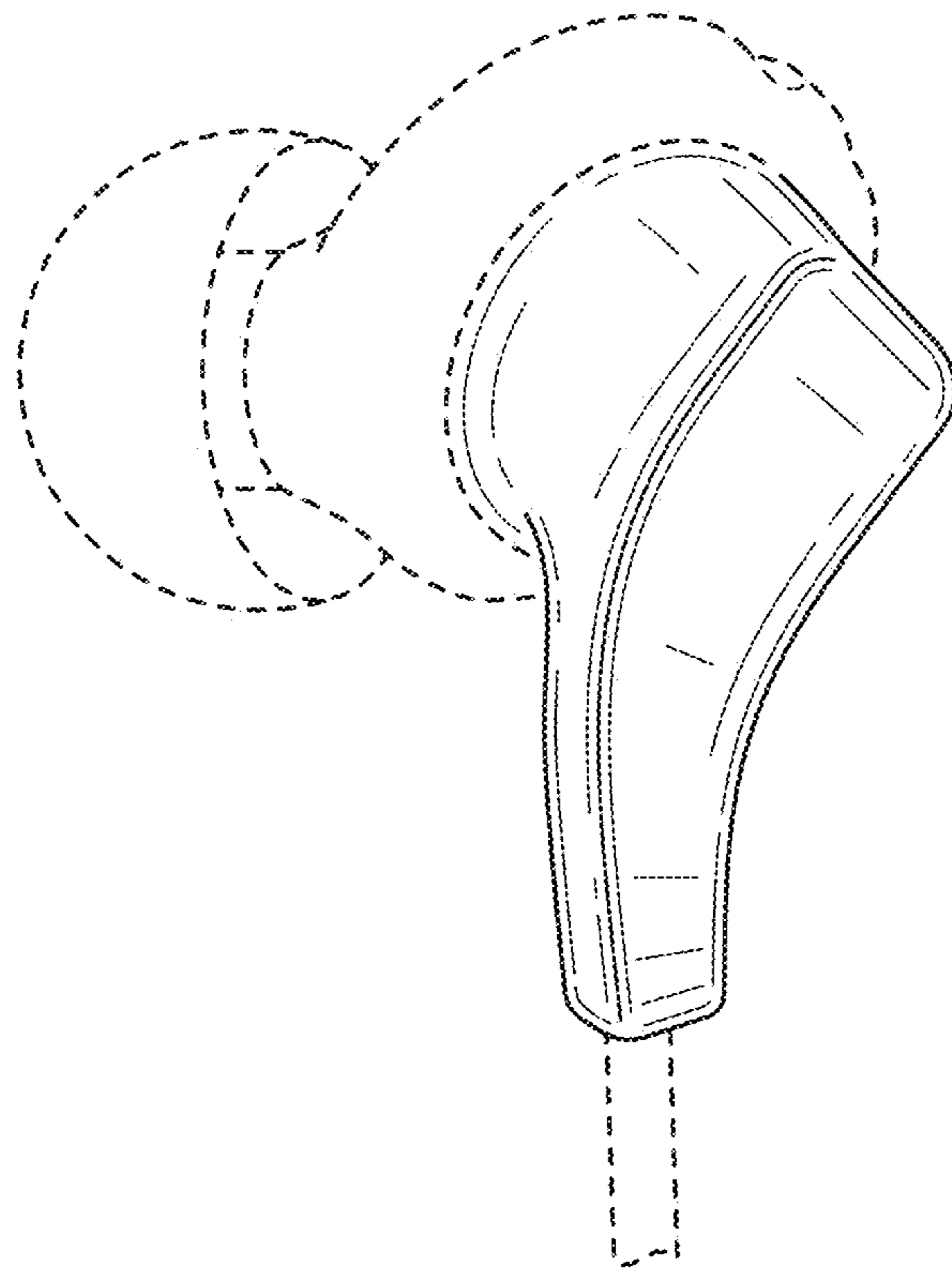
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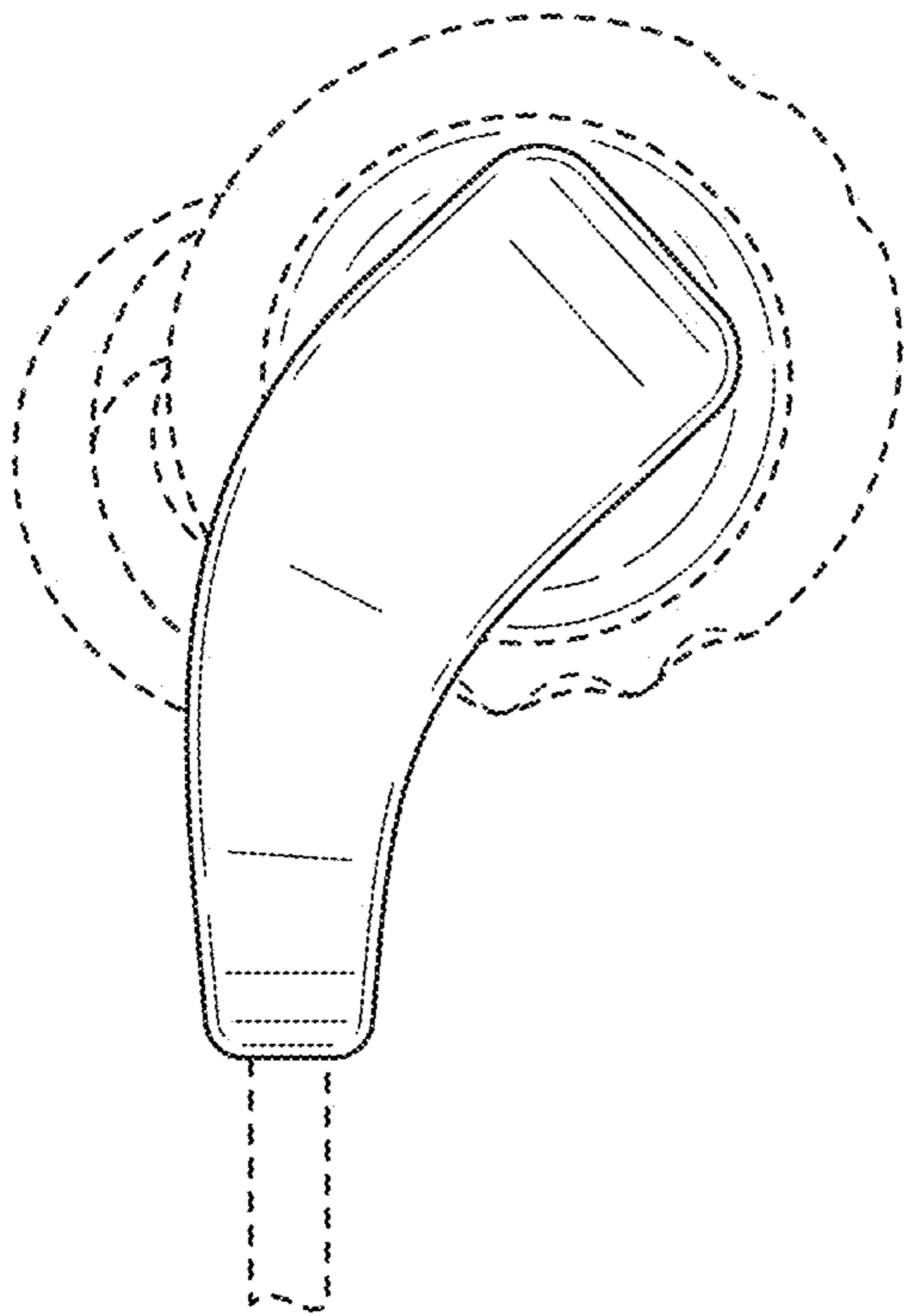
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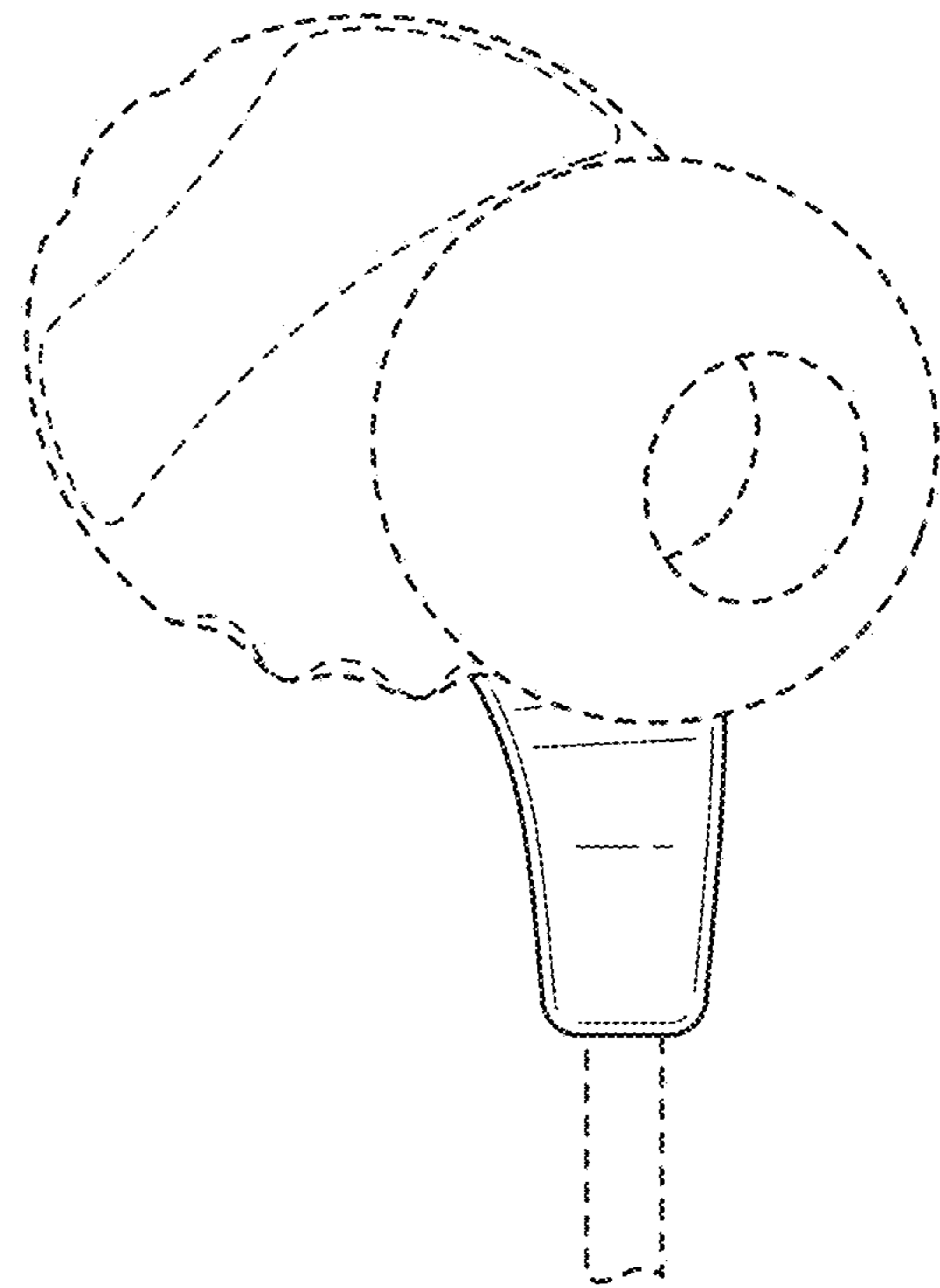
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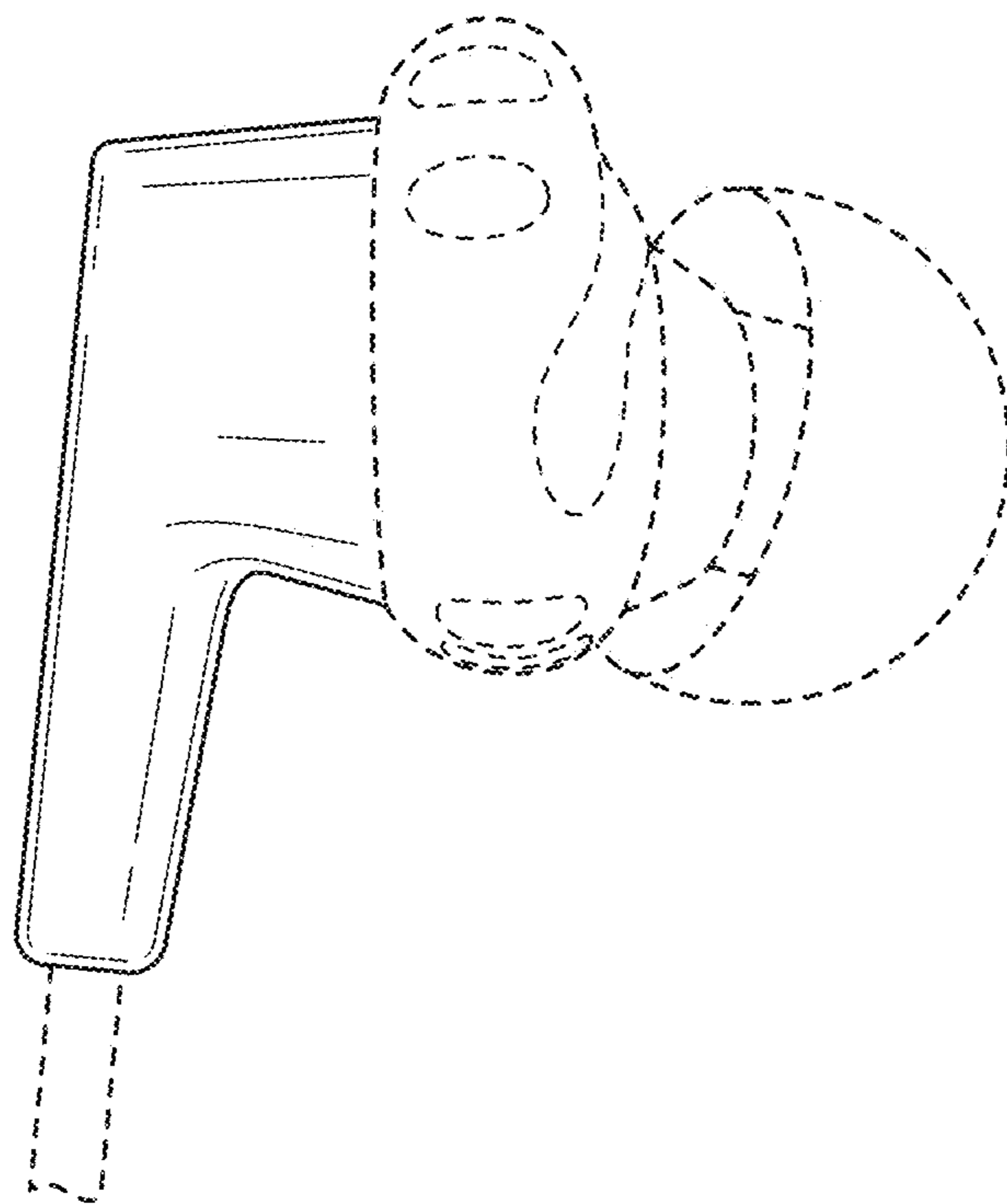
**FIG. 1**



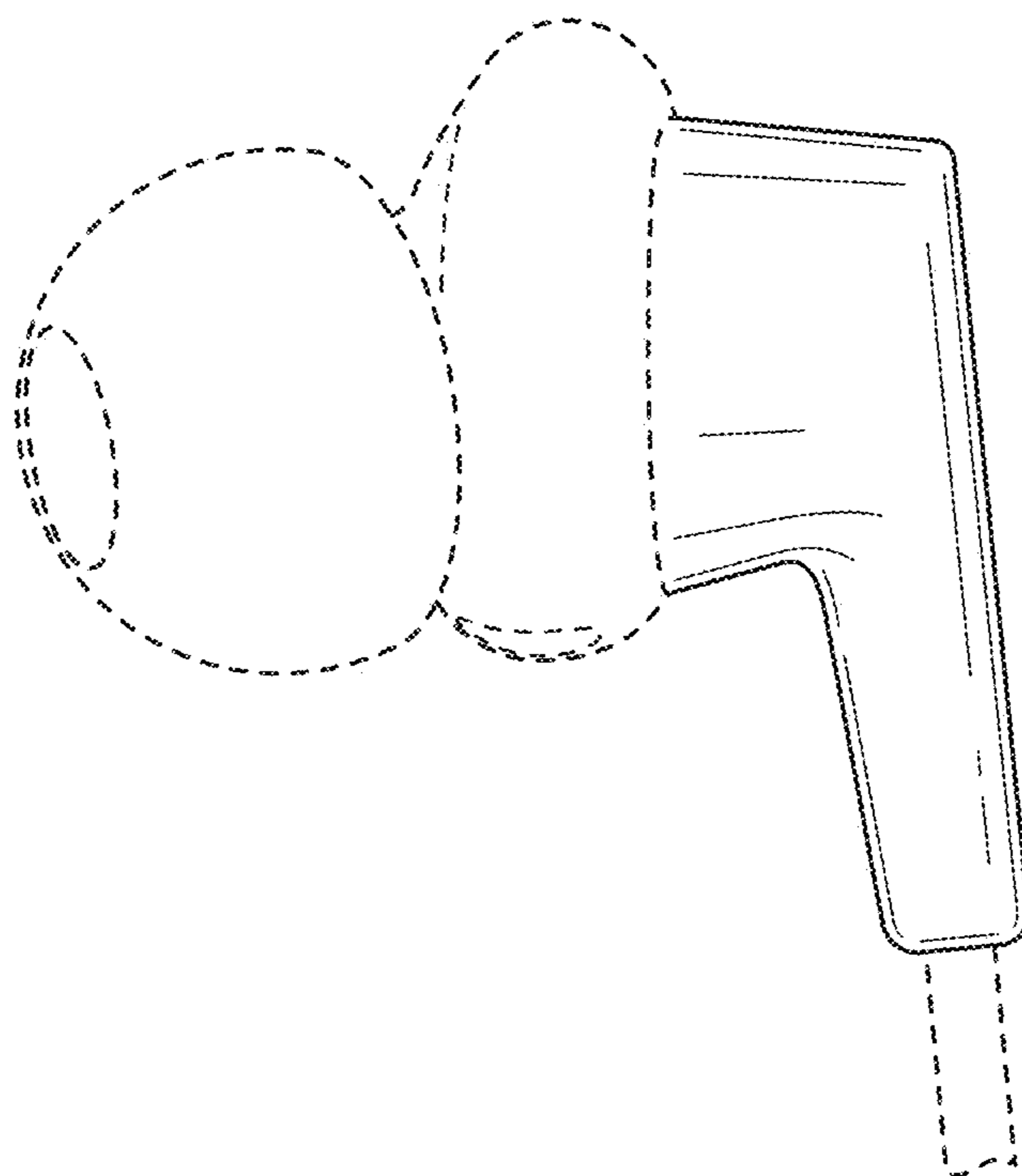
**FIG. 2**



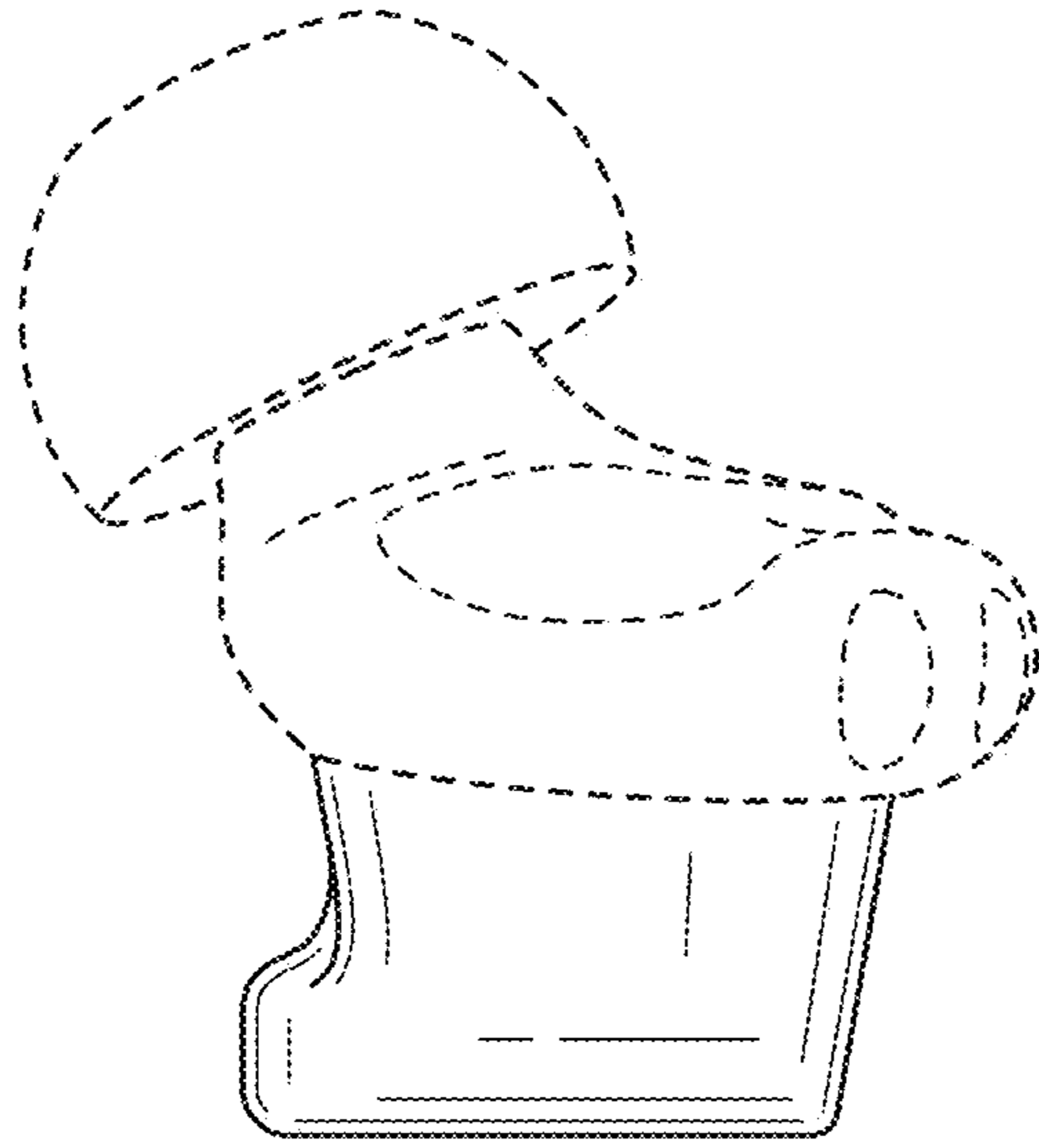
**FIG. 3**



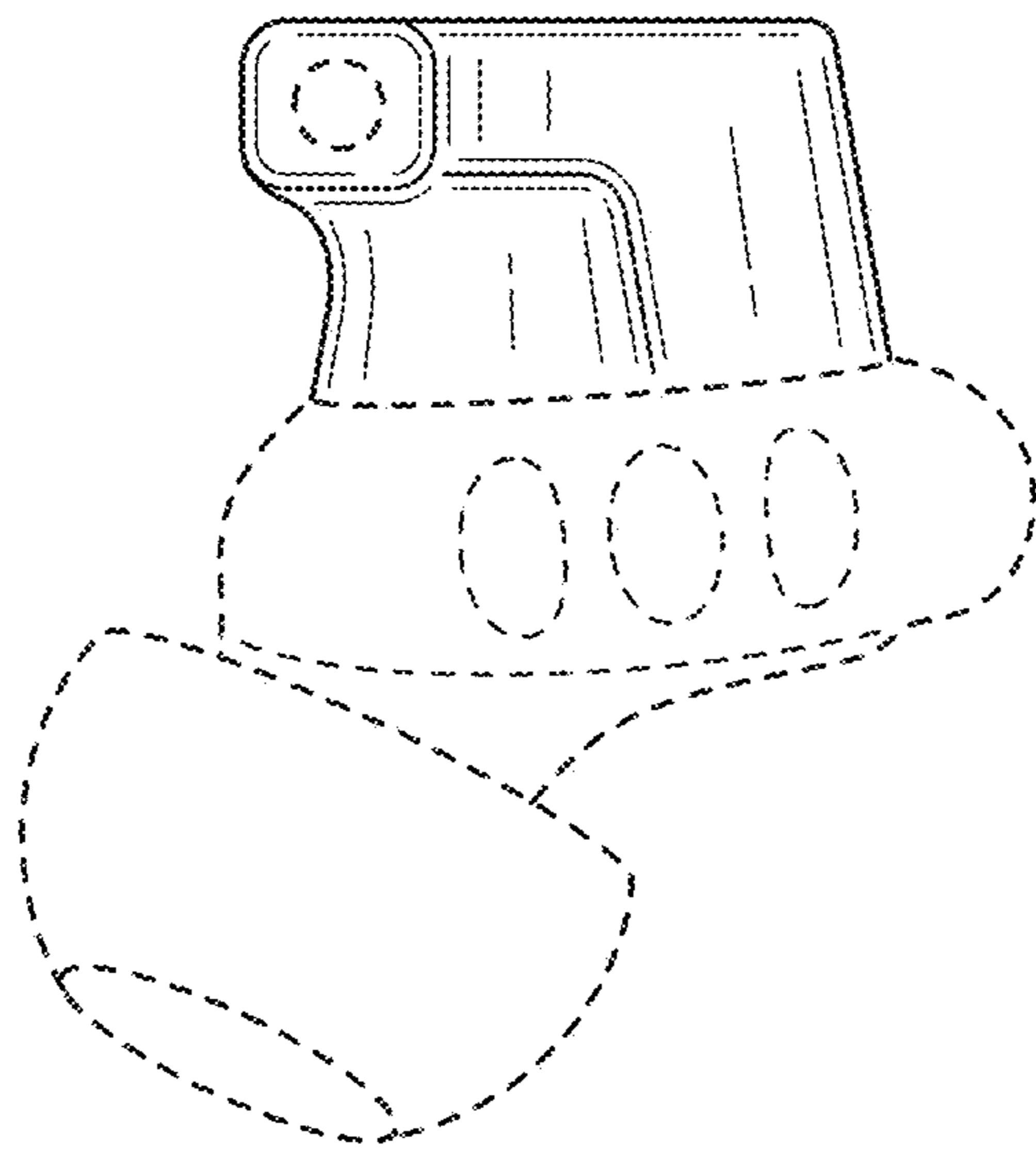
**FIG. 4**



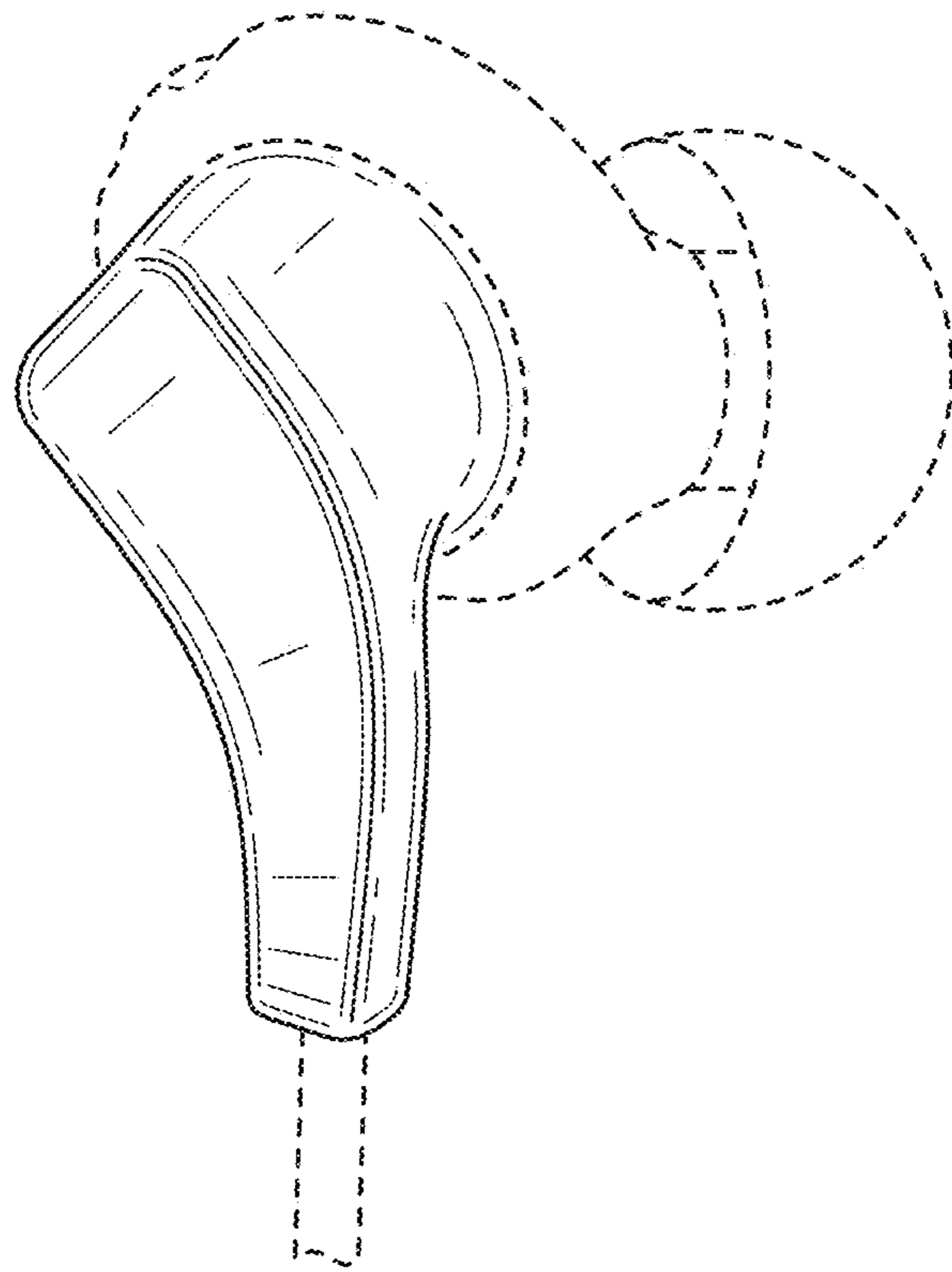
**FIG. 5**



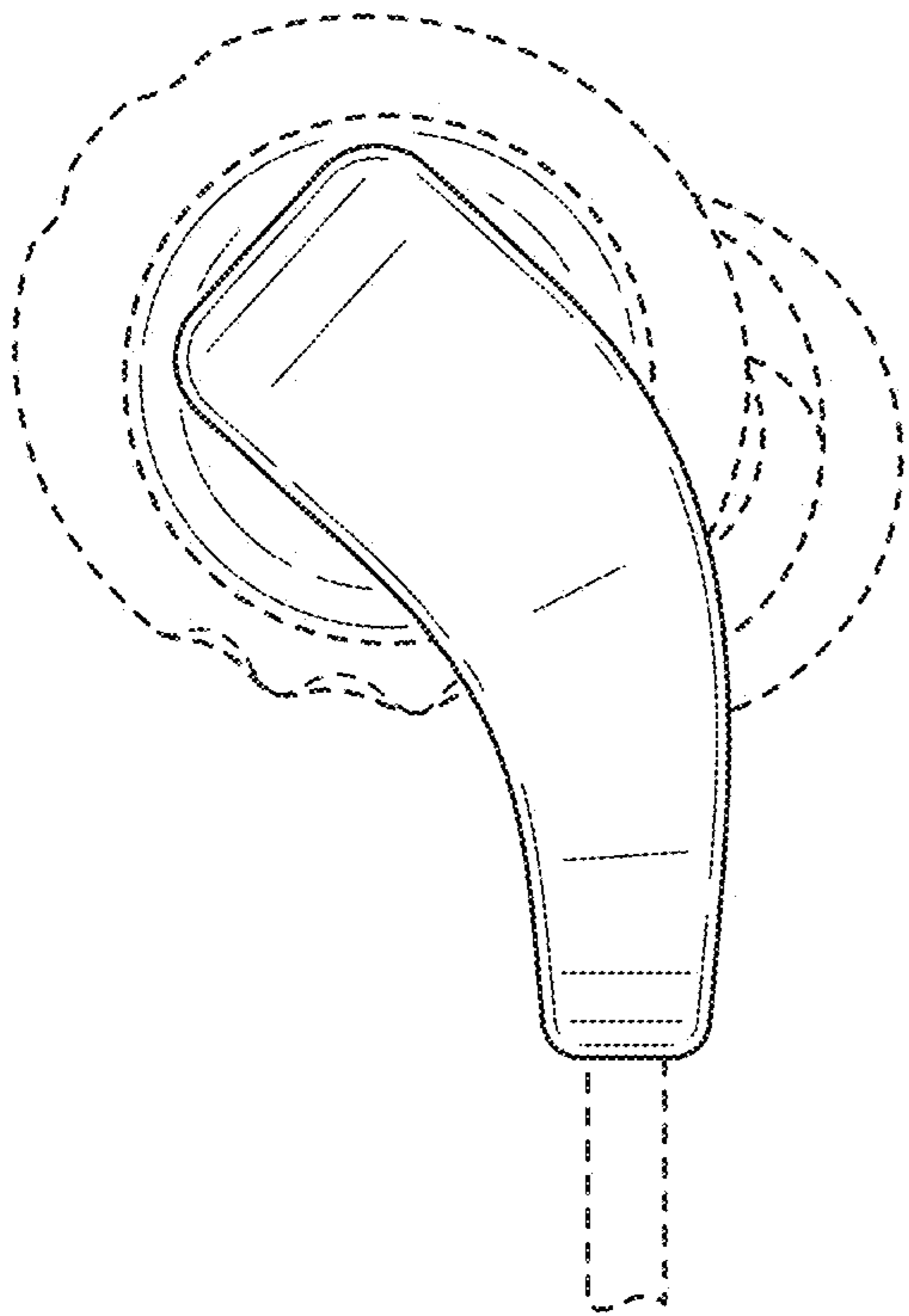
**FIG. 6**



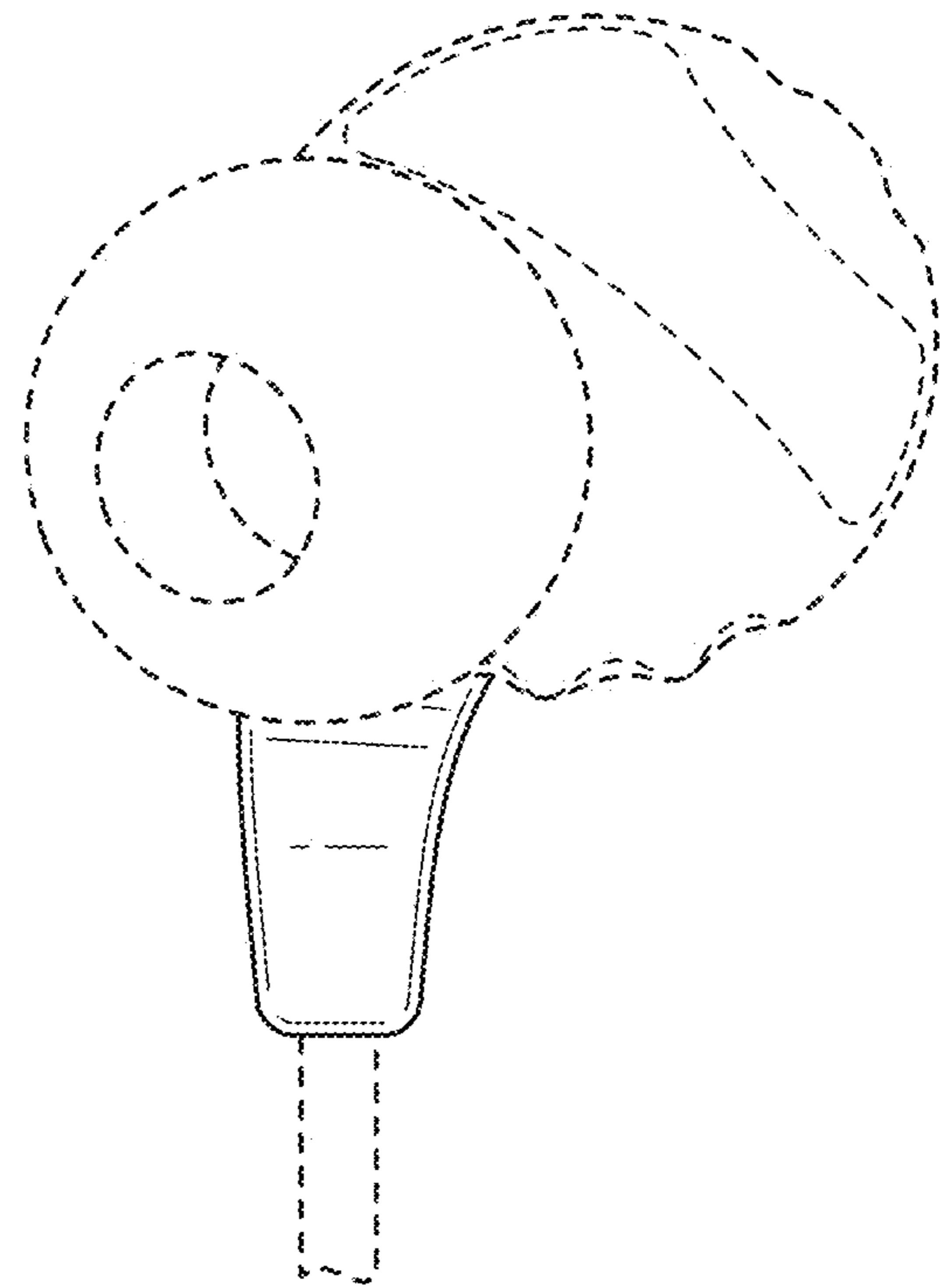
**FIG. 7**



**FIG. 8**

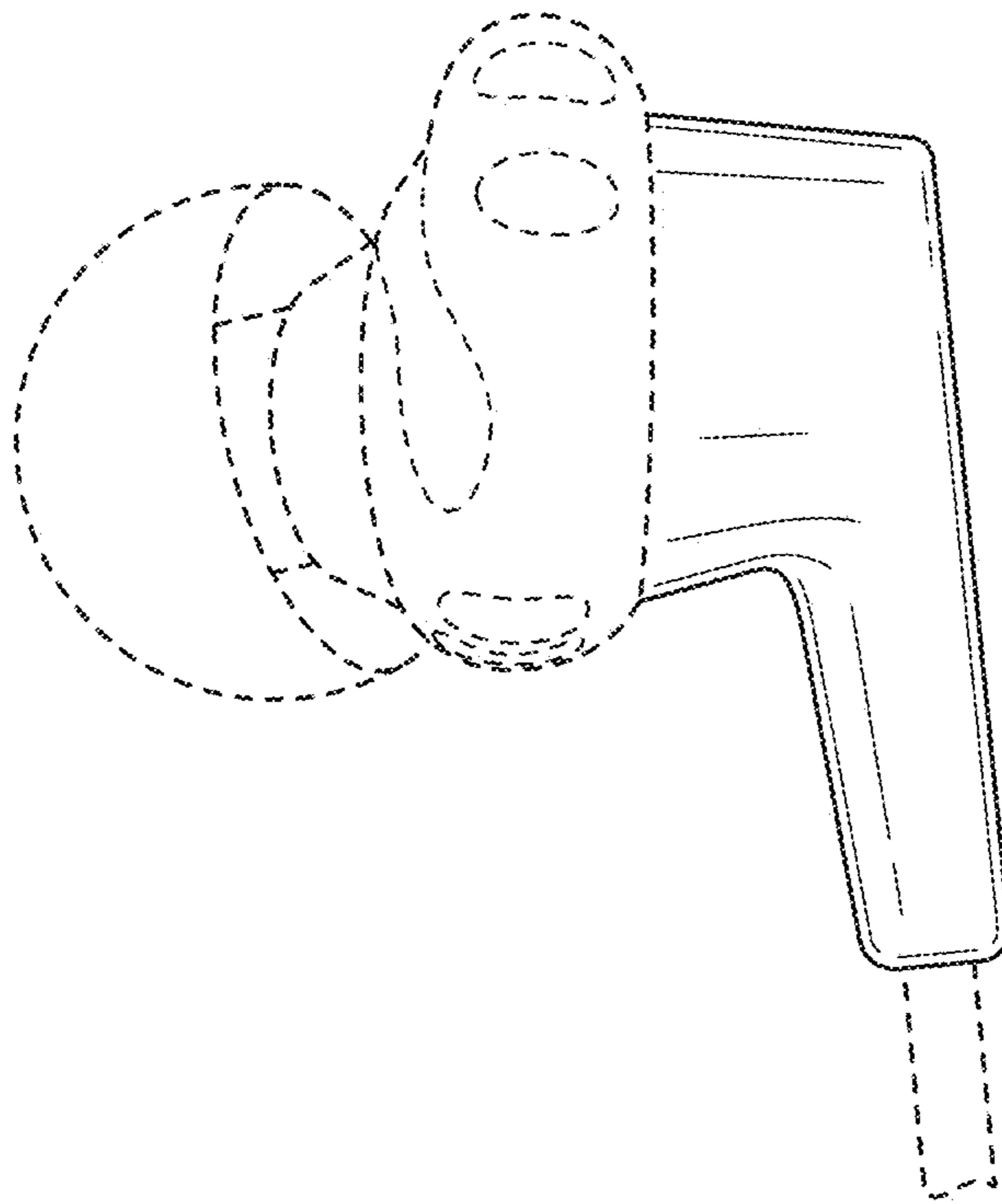


**FIG. 9**

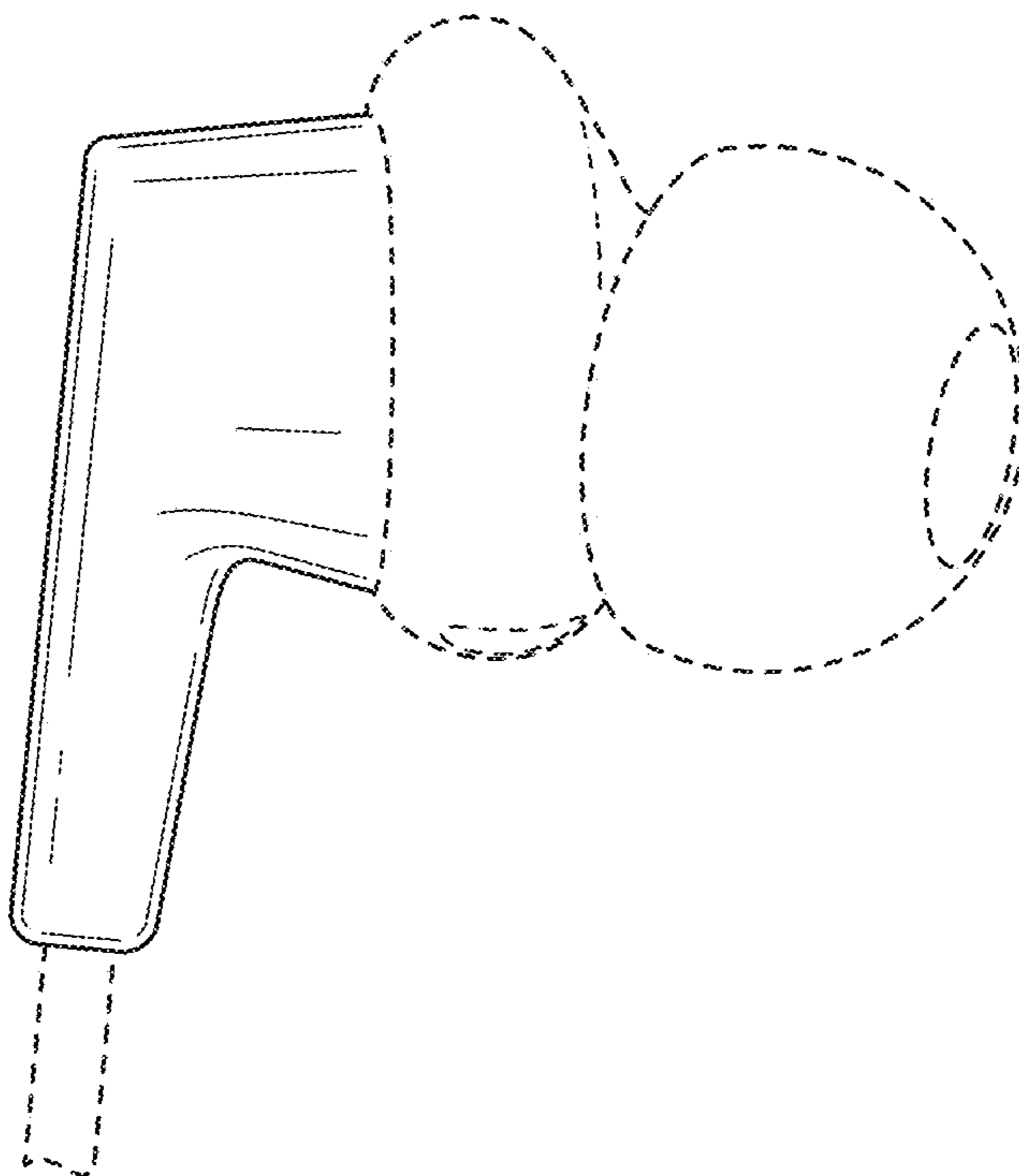


**FIG. 10**

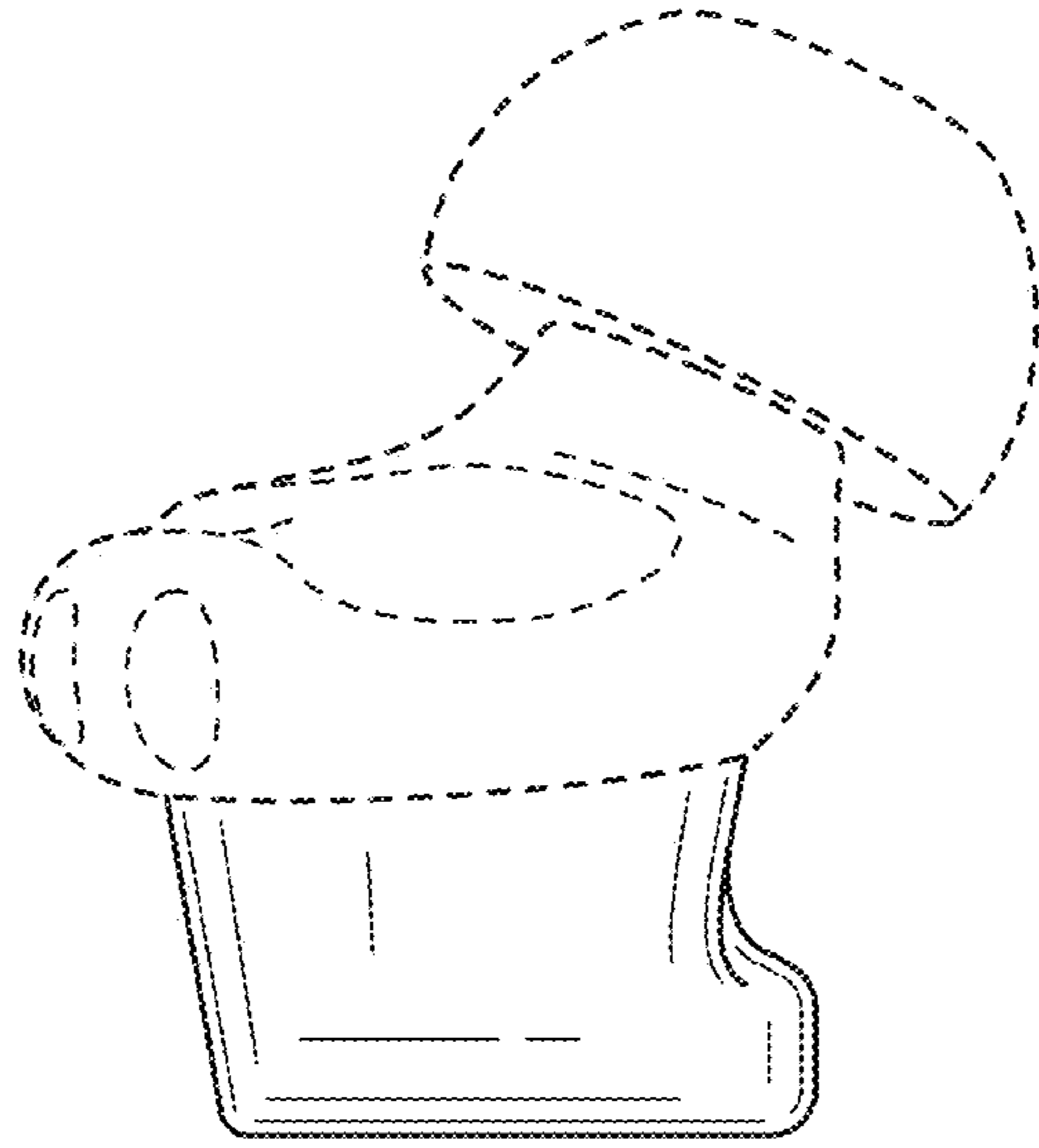




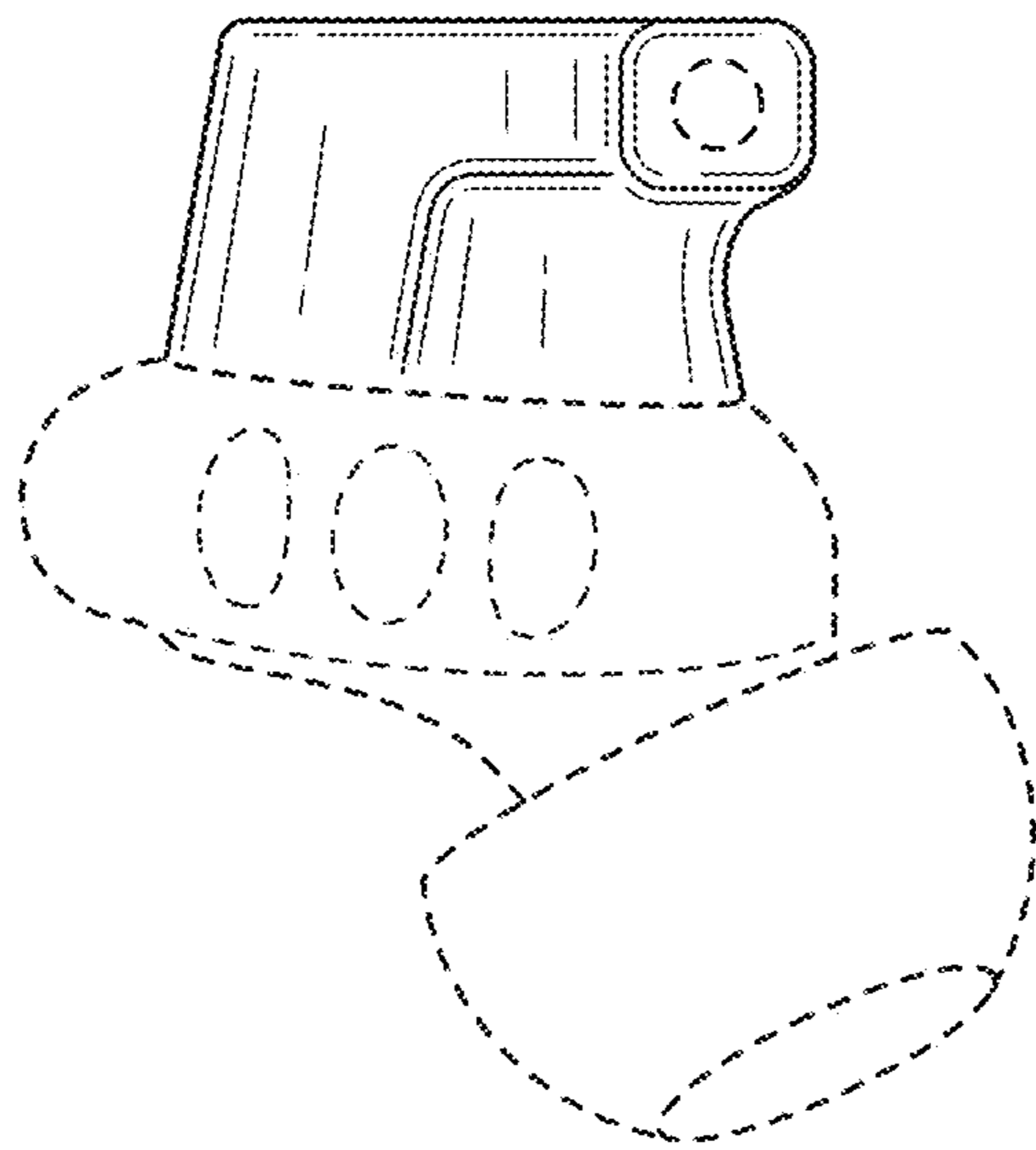
**FIG. 11**



**FIG. 12**



**FIG. 13**



**FIG. 14**